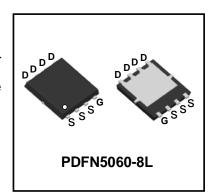


# 30V N-Channel Enhancement Mode Power MOSFET

# **Description**

WMB040N03LG2 uses Wayon's 2<sup>nd</sup> generation power trench MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications.



#### **Features**

- $V_{DS} = 30V$ ,  $I_{D} = 58A$   $R_{DS(on)} < 4.0m\Omega$  @  $V_{GS} = 10V$  $R_{DS(on)} < 6.2m\Omega$  @  $V_{GS} = 4.5V$
- Low R<sub>DS</sub>(on)
- Low Gate Charge
- 100% EAS Guaranteed
- RoHS and Halogen-Free Compliant

# **Applications**

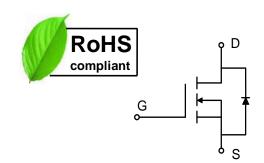
- Power Management in Switches
- DC/DC Converter

# **Absolute Maximum Ratings**

Parameter		Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	±20	V	
Continuous Drain Current <sup>1</sup>	T <sub>C</sub> =25°C	ID	58	^	
	T <sub>C</sub> =100°C		38	Α	
Pulsed Drain Current <sup>2</sup>		I <sub>DM</sub>	118	Α	
Single Pulse Avalanche Energy³		EAS	88	mJ	
Avalanche Current		IAS	42	А	
Total Power Dissipation <sup>4</sup> T <sub>C</sub> =25°C		P <sub>D</sub>	28	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C	

# **Thermal Characteristics**

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient <sup>1</sup>	R <sub>0JA</sub>	51	°C/W
Thermal Resistance from Junction-to-Case <sup>1</sup>	R <sub>θ</sub> Jc	4.5	°C/W





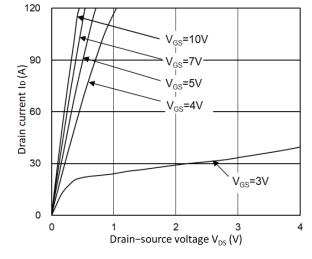
## Electrical Characteristics T<sub>c</sub> = 25°C, unless otherwise noted

Parameter		Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static Characteristics							
Drain-Source Breakdown Voltage		V <sub>(BR)DSS</sub>	$V_{GS} = 0V, I_D = 250\mu A$	30	-	-	V
Gate-body Leakage Current		Igss	$V_{DS}$ = 0V, $V_{GS}$ = $\pm 20$ V	-	-	±100	nA
Zero Gate Voltage Drain Current	T <sub>J</sub> =25°C	IDSS	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V	-	-	1	μA
	T <sub>J</sub> =55°C			-	-	5	
Gate-Threshold Voltage	•	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	-	2.2	V
Drain-Source On-Resistance <sup>2</sup>		_	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A	-	3.6	4.0	- mΩ
		R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 15A	-	5.0	6.2	
Forward Transconductance <sup>2</sup>		<b>g</b> fs	$V_{DS} = 5V, I_{D} = 20A$	-	76	-	S
Dynamic Characteristic	s	1					
Input Capacitance		Ciss	C <sub>iss</sub>		1390	-	pF
Output Capacitance  Reverse Transfer Capacitance		Coss	$V_{DS} = 15V, V_{GS} = 0V, f = 1MHz$	-	680	-	
		Crss		-	53	-	
Switching Characteristi	cs	1					
Gate Resistance		R <sub>G</sub>	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	-	2	-	Ω
Total Gate Charge		Qg		-	15	-	
Gate-Source Charge		$Q_{gs}$	$V_{GS} = 4.5V, V_{DS} = 15V, I_D = 20A$	-	5.9	-	nC
Gate-Drain Charge		$\mathbf{Q}_{gd}$		-	3.5	-	
Turn-on Delay Time  Rise Time  Turn-off Delay Time  Fall Time		t <sub>d(on)</sub>		-	7.7	-	. nS
		tr	$V_{GS} = 10V, V_{DS} = 15V,$ $R_G = 3\Omega, I_D = 20A$	-	20.5	-	
		td(off)		-	21.8	-	
		t <sub>f</sub>		-	4.5	-	
Drain-Source Body Dio	de Charac	teristics	1	1			
Diode Forward Voltage <sup>2</sup>		V <sub>SD</sub>	I <sub>S</sub> = 1A, V <sub>GS</sub> = 0V	-	-	1.0	V
Continuous Source Current	1,5	Is	V <sub>G</sub> = V <sub>D</sub> = 0V , Force Current	-	-	58	Α

#### Notes:

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq 300 \text{us}$  , duty cycle  $\leq 2\%$
- 3. The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}$ =25V,  $V_{\text{GS}}$ =10V, L=0.1mH,  $I_{\text{AS}}$ =42A
- 5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.





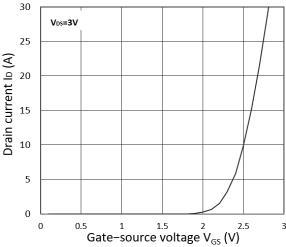
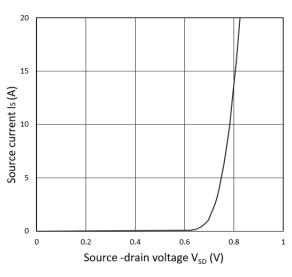


Figure 1. Output Characteristics

Figure 2. Transfer Characteristics



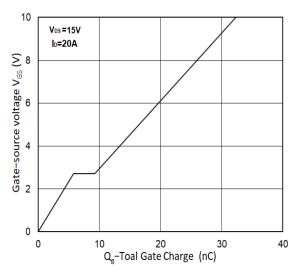
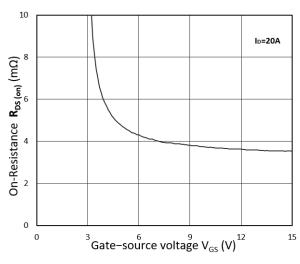


Figure 3. Forward Characteristics of Reverse

Figure 4. Gate Charge Characteristics



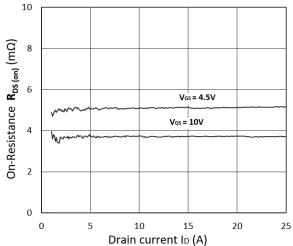


Figure 5. RDS(on) vs. VGS

Figure 6. R<sub>DS(on)</sub> vs. I<sub>D</sub>



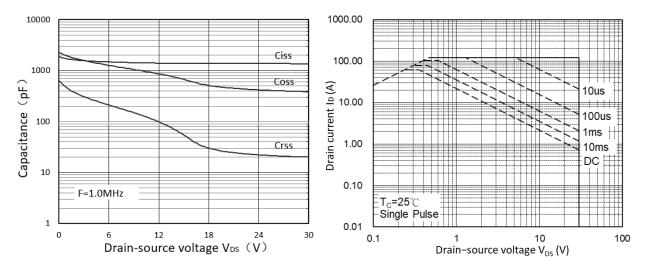


Figure 7. Capacitance Characteristics

Figure 8. Safe Operating Area

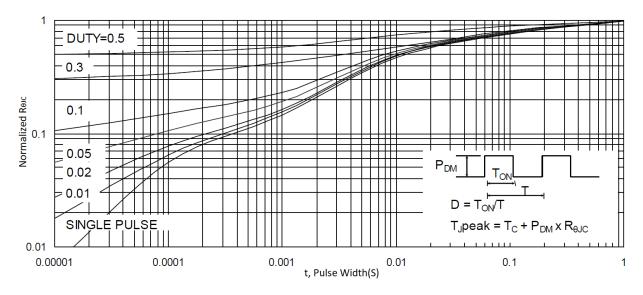


Figure 9. Normalized Maximum Transient Thermal Impedance

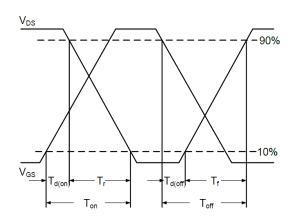


Figure 10. Switching Time Waveform

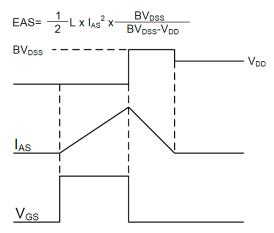
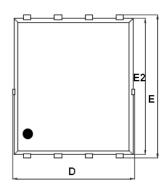


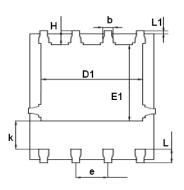
Figure 11. Unclamped Inductive Switching

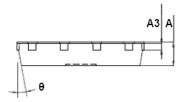
Waveform



## **Mechanical Dimensions for PDFN5060-8L**







## **COMMON DIMENSIONS**

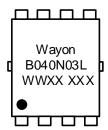
	MM			
SYMBOL	MIN	MAX		
Α	0.90	1.20		
А3	0.15	0.35		
D	4.80	5.40		
Е	5.90	6.35		
D1	3.61	4.31		
E1	3.30	3.92		
E2	5.65	6.06		
k	1.10	-		
b	0.30	0.51		
е	1.27BSC			
L	0.38	0.71		
L1	0.05	0.36		
Н	0.38	0.61		
θ	0° 12°			



## **Ordering Information**

Part	Package	Marking	Packing method	
WMB040N03LG2	PDFN5060-8L	B040N03L	Tape and Reel	

## **Marking Information**



B040N03L = Device code

WWXX XXX= Date code

## **Contact Information**

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WAYON website: http://www.way-on.com

For additional information, please contact your local Sales Representative.

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